

8 Package Specification

The IC comes in a 272-ball Plastic Ball Grid Array (PBGA).

All dimensions are in millimeters.

Symbol	Min	Typical	Max	Description
A	2.20	2.33	2.46	Overall thickness
A1	0.50	0.60	0.70	Ball height
A2	0.51	0.56	0.61	Body thickness
D		27.00 BSC.		Body size
D1		24.13 BSC.		Ball footprint
b	0.60	0.75	0.90	Ball diameter
e		1.27 BSC.		Ball pitch
P		24.00		Encapsulation area

